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 Meets or Exceeds Requirements of ANSI TIA/EIA-422-B and ITU 	D, N, OR NS PACKAGE (TOP VIEW)
Recommendation V.11	
 3-State, TTL-Compatible Outputs 	1A [] 1 ⁻ 16 [] V _{CC} 1Y [] 2 15 [] 4A
 Fast Transition Times 	1Z 🛛 3 14 🗍 4Y
High-Impedance Inputs	1,2EN 🚺 4 13 🗍 4Z
 Single 5-V Supply 	2Z 🛛 5 12 🛛 3,4EN
 Power-Up and Power-Down Protection 	2Y [] 6 11 [] 3Z
 Designed to Be Interchangeable With 	2A 🛛 7 10 🛛 3Y
Motorola MC3487	GND [8 9] 3A

description

The MC3487 offers four independent differential line drivers designed to meet the specifications of ANSI TIA/EIA-422-B and ITU Recommendation V.11. Each driver has a TTL-compatible input buffered to reduce current and minimize loading.

The driver outputs utilize 3-state circuitry to provide high-impedance states at any pair of differential outputs when the appropriate output enable is at a low logic level. Internal circuitry is provided to ensure a high-impedance state at the differential outputs during power-up and power-down transition times, provided the output enable is low. The outputs are capable of source or sink currents of 48 mA.

The MC3487 is designed for optimum performance when used with the MC3486 quadruple line receiver. It is supplied in a 16-pin dual-in-line package and operates from a single 5-V supply.

The MC3487 is characterized for operation from 0°C to 70°C.

AVAILABLE OPTIONS					
	PACKA	GE			
TA	PLASTIC SMALL OUTLINE (D, NS)	PLASTIC DIP (N)			
0°C to 70°C	MC3487D MC3487NS	MC3487N			

AVAILABLE OPTIONS

The D package is available taped and reeled. Add the suffix R to the device type (e.g., MC3487DR). The NS package is only available taped and reeled.

FUNCTION TABLE (each driver)					
INDUT	OUTPUT ENABLE	OUTPUTS			
INPUT		Y	Z		
Н	Н	Н	L		
L	н	L	н		
х	L	Z	Z		

H = TTL high level, L = TTL low level, X = irrelevant, Z = High impedance



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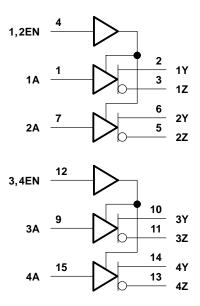
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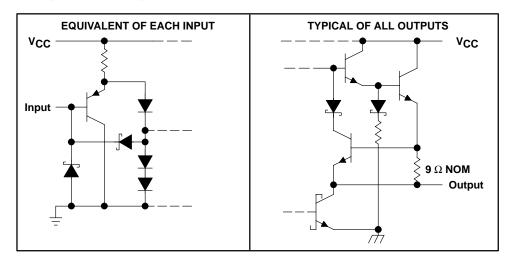
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logic diagram (positive logic)



schematics of inputs and outputs





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1) Input voltage, V _I Output voltage, V _O		5.5 V
Continuous total power dissipation		
Package thermal impedance, θ_{JA} (see Note 2):	D package	
	N package	67°C/W
	NS package	64°C/W
Lead temperature 1,6 mm (1/16 inch) from case Storage temperature range, T _{stg}		•

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential output voltage, VOD, are with respect to the network ground terminal.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

_	DISSIPATION RATING TABLE						
$\begin{array}{c} \textbf{T}_{\textbf{A}} \leq 25^{\circ}\textbf{C} \\ \textbf{POWER RATING} \end{array}$			DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING			
	D	950 mW	7.6 mW/°C	608 mW			
L	Ν	1150 mW	9.2 mW/°C	736 mW			

DISSIPATION RATING TABLE

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.75	5	5.25	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
Τ _Α	Operating free-air temperature	0		70	°C



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electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST	CONDITIONS		MIN	MAX	UNIT	
VIK	Input clamp voltage	lı = – 18 mA				-1.5	V	
^V ОН	High-level output voltage	V _{IL} = 0.8 V,	V _{IH} = 2 V,	I _{OH} = -20 mA	2.5		V	
VOL	Low-level output voltage	V _{IL} = 0.8 V,	V _{IH} = 2 V,	I _{OL} = 48 mA		0.5	V	
IVodi	Differential output voltage	R _L = 100 Ω,	See Figure 1		2			
	Change in magnitude of differential output voltage [†]	R _L = 100 Ω,	See Figure 1			±0.4	V	
Voc	Common-mode output voltage‡	R _L = 100 Ω,	See Figure 1			3	V	
∆IVocl	Change in magnitude of common-mode output voltage [†]	R _L = 100 Ω,	See Figure 1			±0.4	V	
	Output with a second site		V _O = 6 V			100		
10	Output current with power off	VCC = 0	$V_{O} = -0.25 V$			-100	μA	
1	High-impedance-state output current		V _O = 2.7 V		100		μA	
loz	High-Impedance-state output current	Output enables at 0.8 V $V_0 = 0.5 V$			-100			
lı	Input current at maximum input voltage	V _I = 5.5 V	V _I = 5.5 V			100	μA	
IIH	High-level input current	V _I = 2.7 V			50	μA		
۱ _{IL}	Low-level input current	V _I = 0.5 V			-400	μA		
los	Short-circuit output current§	V ₁ = 2 V		-40	-140	mA		
1	Supply surrent (all drivers)	Outputs disabled		Outputs disabled		105	A	
ICC	Supply current (all drivers)	Outputs enabled, No load				85	mA	

 $\Delta |V_{OD}|$ and $\Delta |V_{OC}|$ are the changes in magnitude of V_{OD} and V_{OC} , respectively, that occur when the input is changed from a high level to a low level.

[‡] In ANSI Standard TIA/EIA-422-B, V_{OC}, which is the average of the two output voltages with respect to ground, is called output offset voltage, V_{OS}.

§ Only one output at a time should be shorted, and duration of the short circuit should not exceed one second.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V

PARAMETER		TEST CONDITIONS		MIN	MAX	UNIT
^t PLH	Propagation delay time, low- to high-level output				20	20
^t PHL	Propagation delay time, high- to low-level output	C _L = 15 pF,	See Figure 2		20	ns
t _{sk}	Skew time	C _L = 15 pF,	See Figure 2		6	ns
^t t(OD)	Differential-output transition time	CL = 15 pF,	See Figure 3		20	ns
^t PZH	Output enable time to high level	0 50 - 5			30	
t _{PZL}	Output enable time to low level	С _L = 50 рF,	See Figure 4		30	ns
^t PHZ	Output disable time from high level	$C_1 = 50 \text{pF},$	See Figure 4		25	ns
^t PLZ	Output disable time from low level	0L - 30 pr,			30	115



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PARAMETER MEASUREMENT INFORMATION

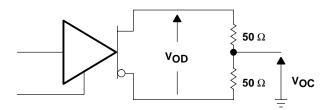
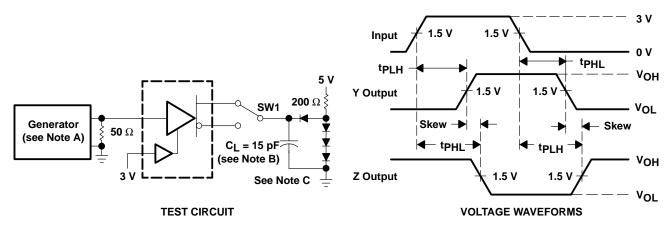


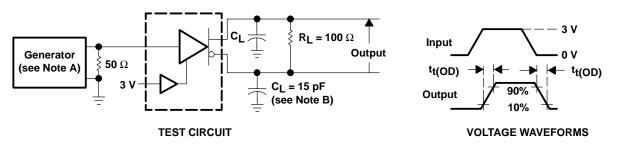
Figure 1. Differential and Common-Mode Output Voltages



NOTES: A. The input pulse is supplied by a generator having the following characteristics: $t_f \le 5$ ns, $t_f \le 5$ ns, PRR ≤ 1 MHz, duty cycle = 50%, $Z_O = 50 \Omega$.

- B. C_{L} includes probe and stray capacitance.
- C. All diodes are 1N916 or 1N3064.

Figure 2. Test Circuit and Voltage Waveforms

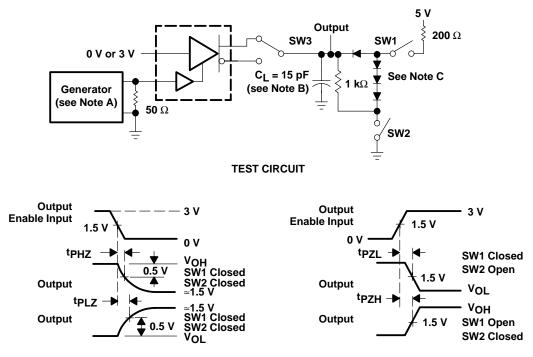


- NOTES: A. The input pulse is supplied by a generator having the following characteristics: $t_r \le 5$ ns, $t_f \le 5$ ns, $PRR \le 1$ MHz, duty cycle = 50%, $Z_O = 50 \Omega$.
 - B. CL includes probe and stray capacitance.

Figure 3. Test Circuit and Voltage Waveforms



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PARAMETER MEASUREMENT INFORMATION

VOLTAGE WAVEFORMS

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: $t_f \le 5$ ns, $t_f \le 5$ ns, PRR ≤ 1 MHz, duty cycle = 50%, $Z_O = 50 \Omega$.
 - B. CL includes probe and stray capacitance.
 - C. All diodes are 1N916 or 1N3064.

Figure 4. Driver Test Circuit and Voltage Waveforms



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